



technical datasheet

General description

High and low temperature resistant multipurpose hotmelt adhesive.

TECBOND 7784 is a tough flexible polyamide based adhesive that exhibits excellent adhesion to many difficult to bond substrates. Suitable for product assembly, woodworking, and packaging applications that require both high and low heat resistance.

Technical characteristics

Adhesive type: Synthetic Polymer Based Hotmelt

Colour: Amber Molten tack: Very high

	1/2"	5/8"	13/4"	СТ	Bulk
Form	½" x 10"	5⁄8" x 10"	1¾" x 1¾"		Prills
Sticks per lb (approx)	18	11	8		
Carton quantity	22lb (4x5.5lb foil pack)	22lb (4x5.5lb foil pack)	22lb (tub)		44lb
Alternative Pack	10x10 stick pack	10x6 stick pack			
Pallet weight:	1100lb	1100lb	1100lb		2200lb
Suggested application temperature	380-420°F	380-420°F	380-420°F		380-420°F
Brookfield viscosity (POW-12-VISC) spindle 27	6000cps @ 350°F	6000cps @ 350°F	6000cps @ 350°F		6000cps @ 350°F
Ring & ball softening point (ASTM E28)	275°F	275°F	275°F		275°F
Heat resistance (BS5350 Part H3)	220°F	220°F	220°F		220°F
Open time	Medium	Medium	Medium		Medium
Low temperature flexibility (tg)	-76°F	-76°F	-76°F		-76°F
Applicators or hotmelt system	▼ Tec 150-12 □ Tec 150-12LM ▼ Tec 175-12 □ Tec 175-12LM ▼ Tec 250-12 □ Tec 250-12LM ▼ Gastec 100 ▼ Gastec 300 ▼ Gastec 500 ▼ Tec 810-12 □ Tec 810-12LM	Tec 810-15 Tec 810-15LM	▼ Tec 3150-43 □ Tec 3150-43LM ▼ Tec 3200-43 ▼ Tec 6100-43 □ Tec 6300-43 ▼ Tec 7100-43 □ Tec 7300-43	Tec 1050	Bulk tank Spray Jet Slot coater Roller PUR system

F.D.A. approved. All the constituent parts of this adhesive have been approved by the American F.D.A. under C.F.R. 21.175.105 (adhesives) (subject to limitations).

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Tecbond Reference	Description	1/2"	5/8"	1¾"	СТ	Bulk
5	High delivery, low viscosity, long open time. Product assembly adhesive.	•		•	•	•
14	High delivery, very fast setting packaging adhesive.	•	•	•		
1942	Product assembly adhesive for wood and many plastics.	•	•	•		
1X	Low viscosity, wood working & packaging adhesive. Medium open time.	•		•		
213	Economical, general purpose adhesive.	•	•	•		
214	Economical, fast setting, packaging adhesive.	•	•	•		
23	Medium viscosity multipurpose adhesive.	•	•	•		
232	Economical, clear, general purpose adhesive.	•	•	•		
232 Coloured	Coloured, medium open time, general purpose adhesive. Brown, Green, White, Black, Blue, Gold, Silver, Red, Yellow.	•				
232 Glitter	Multicolour, Red, Green, Silver, Gold.	•				
240	High delivery, long open time, multipurpose, clear adhesive.	•	•	•		
246	Clear and black versions, high performance, gap filling, difficult surfaces, dent pulling.	•				
260	High performance, long open time, tough, flexible adhesive.	•	•	•		
265	Long open time product assembly adhesive for smooth and shiny surfaces.			•		
267	High heat resistant, medium open time, product assembly adhesive.			•		
2169	Peelable adhesive, low tack, non-migrating, CD & credit card attachment, glue dots.				•	•
342	High viscosity, fast setting, white adhesive.	•		•		
410	Pallet stabilisation spray adhesive			•		
420	General purpose spray adhesive.			•		
425	High delivery, high performance, spray adhesive.			•		
430	High performance, long open time spray adhesive.			•		
4741	Full pressure sensitive, very aggressive, multipurpose, paper & plastic materials.				•	•
7718	Coloured, low viscosity, potting, encapsulation & knot filling / wood repair polyamide adhesive.	•	•			
7784	High temperature resistant multipurpose polyamide adhesive.	•	•	•		
7785	High temperature & chemical resistant multipurpose polyamide adhesive.	•	•	•		
9010	Reactive hotmelt. Heat & chemical resistant bonds, rigid bond, once set does not reactivate with heat.				•	
9030	Reactive hotmelt. Heat & chemical resistant bonds, flexible bond, once set does not reactivate with heat.				•	
LM44	Lowmelt, fast setting, high performance, white adhesive.	•		•		

Storage Store in a clean dry place at temperatures between 41°F and 86°F with boxes closed. Do not expose to direct sunlight or localised heat

sources such as radiators or hot pipes.

Removal of glue Assembled components can be separated by heating assembly to a temperature slightly above the heat resistance figure.

EVA & Polypropylene: Residues of EVA and polypropylene based hotmelts can be removed from components with white spirit.

Polyamide: Residues of polyamide based hotmelt can be removed from components with acetone.

PUR: Prior to cross linking adhesive can be removed with white spirit or ketone. Once fully cross linked the adhesive cannot be easily

emoved.

Please note The information contained on this data sheet is for guidance only. It is the result of careful laboratory evaluations by trained and

qualified staff using British Standard or similar test methods. However, no warranty is expressed or implied regarding the accuracy of the data or the suitability of the adhesive for any specific purpose. In every case, we strongly recommend that the user shall make their own test to determine to their own satisfaction the suitability of the adhesive for their particular purpose. Neither the seller nor manufacturer shall be liable for any injury, loss, damage, direct or consequential arising out of the use or inability to use the product. Further information is always available to help solve your adhesive problems. Should you require any further information on our

adhesives please contact your nearest distributor.







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